

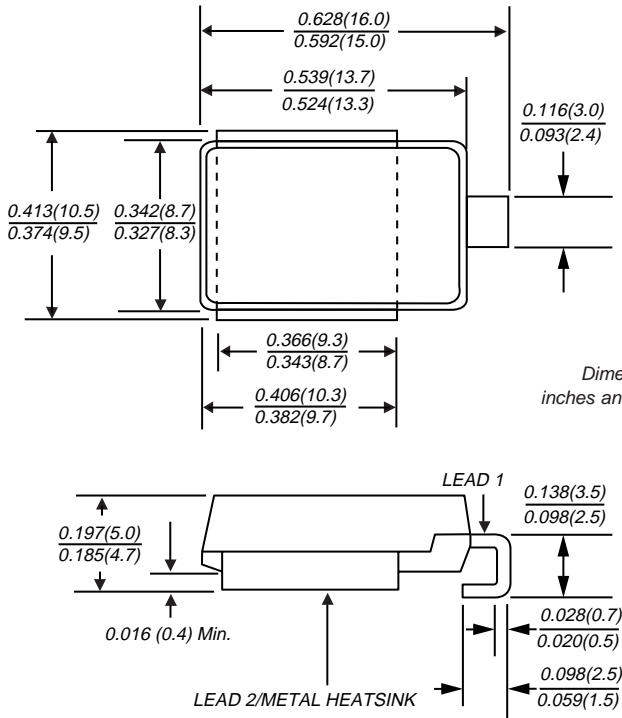


# Surface Mount Automotive Transient Voltage Suppressor



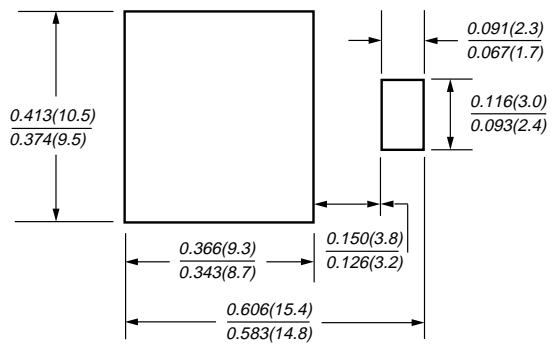
DO-218AB

Zener Voltage 27V Peak Pulse Current 130A(10/10,000µs)  
Peak Pulse Power 6600W (10/1,000µs)



Patented\*

## Mounting Pad Layout



\*Patent #s:  
4,980,315  
5,166,769  
5,278,095

## Features

- Ideally suited for load dump protection
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- High temperature stability due to unique oxide passivation and patented PAR® construction
- Integrally molded heatsink provides a very low thermal resistance for maximum heat dissipation
- Low leakage current at T<sub>J</sub> = 175°C
- High temperature soldering guaranteed: 260°C for 10 seconds at terminals
- Meets ISO7637-2 surge spec.
- Low forward voltage drop

## Mechanical Data

- Case:** Molded plastic body, surface mount with heatsink integrally mounted in the encapsulation
- Terminals:** Plated, solderable per MIL-STD-750, Method 2026
- Polarity:** Heatsink is anode
- Mounting Position:** Any
- Weight:** 0.091 oz., 2.58 g
- Packaging codes/options:**
  - 2D/750 per 13" Reel (16mm Tape), anode towards sprocket hole, 4.5K/box
  - 2E/750 per 13" Reel (16mm Tape), cathode towards sprocket hole, 4.5K/box

## Maximum Ratings and Thermal Characteristics (T<sub>C</sub> = 25°C unless otherwise noted)

| Parameter   | Symbol                            | Value       | Unit |
|---|-----------------------------------|-------------|------|
| Steady state power dissipation  | P <sub>D</sub>                    | 8.0         | W    |
| Non-repetitive peak reverse surge current for 10µs/10ms exponentially decaying waveform | I <sub>RSM</sub>                  | 130         | A    |
| Maximum working stand-off voltage   | V <sub>WM</sub>                   | 22.0        | V    |
| Peak forward surge current 8.3ms single half sine-wave                                  | I <sub>FSM</sub>                  | 700         | A    |
| Typical thermal resistance junction to case   | R <sub>θJC</sub>                  | 0.90        | °C/W |
| Operating junction and storage temperature range  | T <sub>J</sub> , T <sub>STG</sub> | -55 to +175 | °C   |



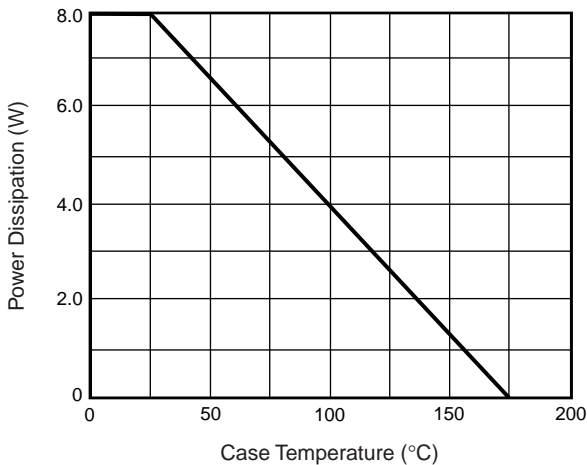
## Electrical Characteristics ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

| Parameter  | Symbol    | Min  | Typ  | Max  | Unit                       |
|--|-----------|------|------|------|----------------------------|
| Reverse zener voltage at 10mA  | $V_Z$     | 24.0 | –    | 30.0 | V                          |
| Zener voltage temperature coefficient at $I_Z = 10\text{mA}$   | $V_{ZTC}$ | –    | –    | 36   | $\text{mV}/^\circ\text{C}$ |
| Clamping voltage for 10 $\mu\text{s}$ /10ms exponentially decaying waveform at $I_{PP} = 75\text{A}$ | $V_C$     | –    | –    | 40.0 | V                          |
| Instantaneous forward voltage <sup>(1)</sup>   | $V_F$     | –    | 0.93 | 0.98 | V                          |
|  |           | –    | –    | –    | –                          |
| Reverse leakage current at rated $V_{WM}$  | $I_R$     | –    | –    | 1.0  | $\mu\text{A}$              |
|  |           | –    | –    | 50.0 | –                          |

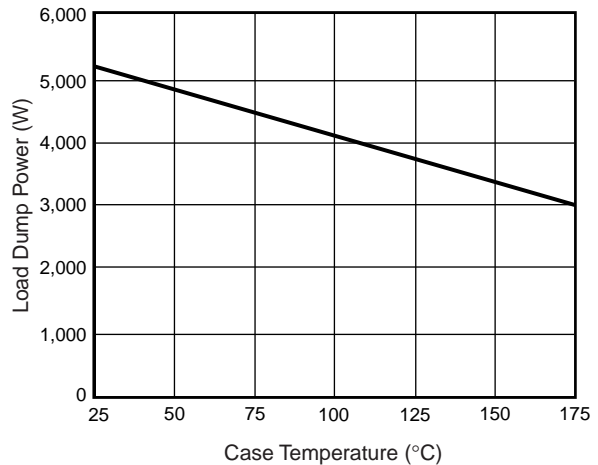
Notes: (1) Measured on a 300 $\mu\text{s}$  square pulse width

## Ratings and Characteristic Curves $T_A=25^\circ\text{C}$ unless otherwise noted.

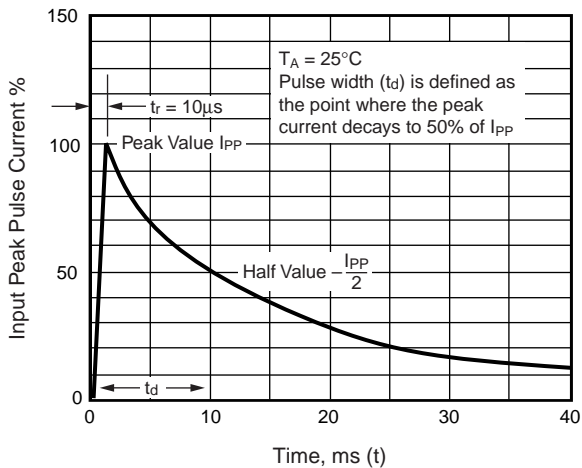
**Power Derating Curve**



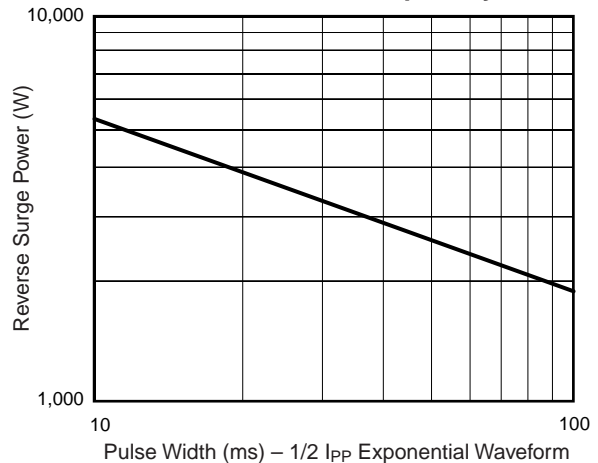
**Load Dump Power Characteristics (10ms Exponential Waveform)**



**Pulse Waveform**



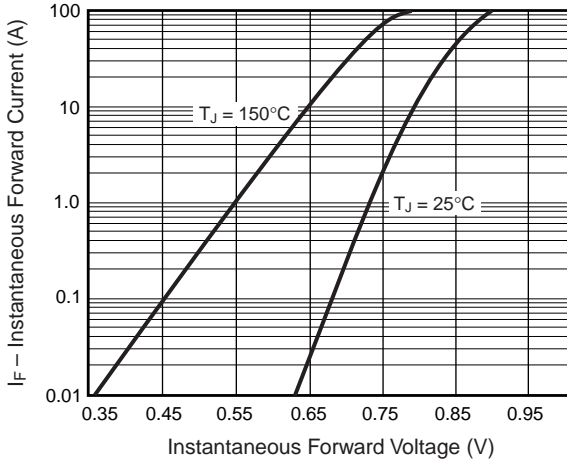
**Reverse Power Capability**



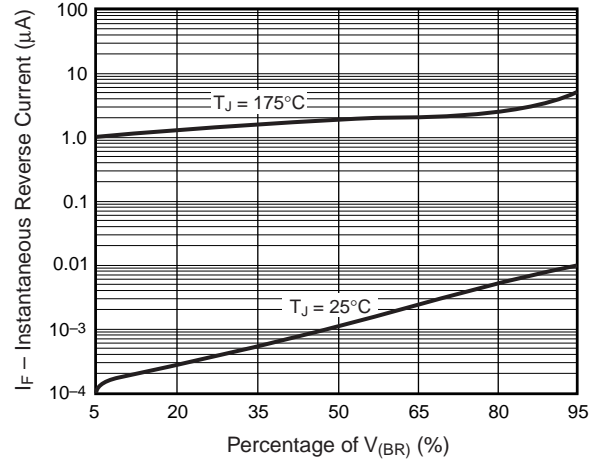


**Ratings and  
Characteristic Curves** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

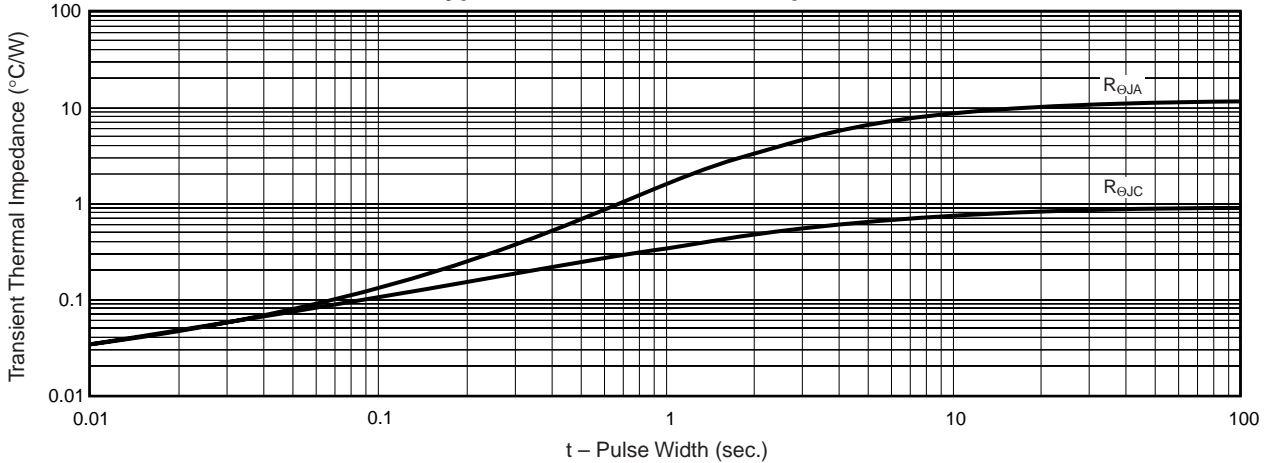
**Typical Instantaneous  
Forward Characteristics**



**Typical Reverse Characteristics**



**Typical Transient Thermal Impedance**



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